



0400 #530-01
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IR-1773 (2-2498)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

New York, New York

Mark Pavier

Date: January 22, 2001

Serial No.: 09/718,932

Group Art Unit:

Filed: November 22, 2000

Examiner:

For: POWER SEMICONDUCTOR DIE ATTACH PROCESS USING
CONDUCTIVE ADHESIVE FILM

Asst. Commissioner for Patents

Washington, D.C. 20231

PRELIMINARY AMENDMENT

Sir:

Preliminary to the examination of the above-identified application, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please amend the specification as follows:

Page 3, line 10, change "8" (second occurrence) to --7--;
line 21, change "11" to --12--.

Page 4, line 27, change "21" to --20--.

IN THE DRAWINGS:

Please amend Fig. 5 as shown in red on the attached copy thereof (in which numerals 20 and 21 are reversed).